

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Lee, et al

Serial No.: 10/824,035

Filed: April 14, 2004

Confirmation No. 6030

Group Art Unit: 2811

Examiner: Vu, Hung K.

Docket No. 252011-2220

Top-Team ref: 0503-A30220US

For: **BONDING PAD STRUCTURE AND METHOD OF FORMING THE SAME**

AMENDMENT AND RESPONSE TO OFFICE ACTION

Mail Stop – Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

The Office Action mailed on June 15, 2006, has been carefully considered. In response thereto, Applicants hereby submit the following remarks.